

NOTES:

1.MATERIAL:

HOUSING:HIGH TEMP THERMOPLASTIC,UL94V-0,COLOR:BLACK
PC 99 COLORFUL INSULATOR:PANTONE#2715C
TERMINAL:PHOSPHOR BRONZE
METAL SHELL:SPCC
BOARD LOCK & NUT:BRASS

2.PLATING:

TERMINAL:

CONTACT AREA:SELECTIVE GOLD(Au) PLATING
SOLDER TAIL:TIN(Sn),THICKNESS=100 MICROINCH MIN.(2.54 MICROINCH MIN.)
UNDER PLATE:NICKEL(Ni),THICKNESS=50 MICROINCH MIN.(1.27 MICROMETER MIN.)

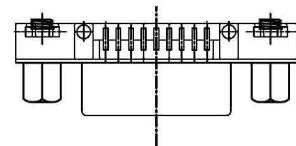
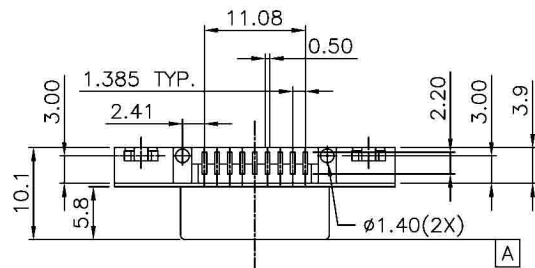
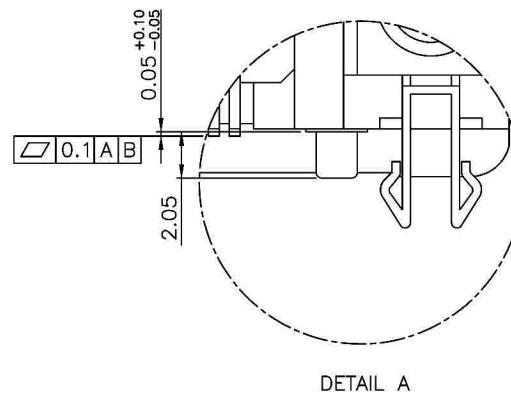
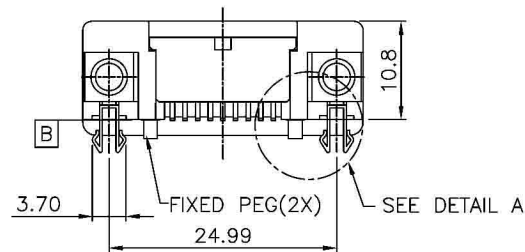
METAL SHELL:

NICKEL(Ni),THICKNESS=80 MICROINCH MIN.(2.032 MICROMETER MIN.)
UNDER PLATE:COPPER(Cu),THICKNESS=40 MICROINCH MIN.(1.016 MICROMETER MIN.)

BOARD LOCK:

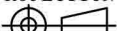
TIN(Sn),THICKNESS=80 MICROINCH MIN.(2.032 MICROMETER MIN.)
UNDER PLATE:NICKEL(Ni),THICKNESS=50 MICROINCH MIN.(1.27 MICROMETER MIN.)
NUT:NICKEL(Ni),THICKNESS=50 MICROINCH MIN.(1.27 MICROMETER MIN.)

3.RECOMMENDED PCB THICKNESS:1.60±0.05mm



N=Without Jackscrews

Y=With Jackscrews

TOLERANCE UNLESS OTHERWISE SPECIFIED		PROJECTION 	 GOLD-TEK ELECTRIC CO., LTD.	
LINEAR		UNITS	TITLE D-Sub 9 Pos. Female Right Angle SMT Slim Type	PART NO. DENM09SN*2*TS
ANGLE				
X. ±	X°. ±			
.X ± 0.30	.X° ±			
.XX ± 0.20	.XX° ±			
.XXX ±		MM	CAD NO. I0040A	
.XXX° ±		SCALE	F:\PDF\DSUB\DSUB-0092	
APPD		SIZE A4	CPART NO.	SHEET 1 OF 1
CHKD			圖面編號:GTKSD1454-C(1)	
DRAW	Z MAY.12'2015			